



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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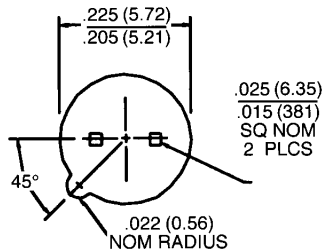
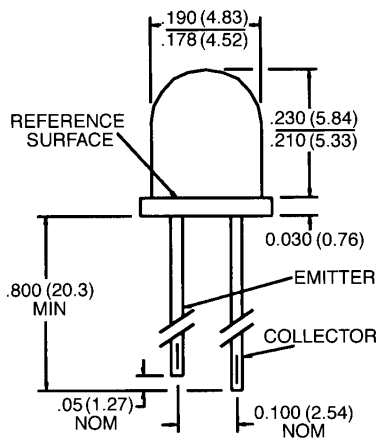
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PACKAGE DIMENSIONS



ST2145

DESCRIPTION

The QSD42X is a silicon phototransistor encapsulated in an infrared transparent, black TO-18 package.

FEATURES

- Tight production distribution.
- Steel lead frames for improved reliability in solder mounting.
- Good optical-to-mechanical alignment.
- Narrow reception angle.
- Plastic package is infrared transparent black to attenuate visible light.
- Mechanically and spectrally matched to the QED423/523 LED.
- Black plastic body allows easy recognition from LED.

NOTES:

1. DIMENSIONS ARE IN INCHES (mm).
2. TOLERANCE IS $\pm .010 (.25)$ UNLESS OTHERWISE SPECIFIED.
3. TAB DENOTES EMITTER.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified)	
Storage Temperature	-40°C to $+100^\circ\text{C}$
Operating Temperature	-40°C to $+100^\circ\text{C}$
Soldering:	
Lead Temperature (Iron)	240°C for 5 sec. ^(4,5)
Lead Temperature (Flow)	260°C for 10 sec. ^(2,5)
Collector-Emitter Breakdown Voltage	30 Volts
Emitter-Collector Breakdown Voltage	5.0 Volts
Power Dissipation	$100\text{ mW}^{(1)}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified) (All measurements made under pulse conditions.)						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Collector-Emitter Breakdown	BV_{CEO}	30	—	—	V	$I_C = 1.0\text{ mA}$
Emitter-Collector Breakdown	BV_{ECO}	5.0	—	—	V	$I_E = 100\ \mu\text{A}$
Collector-Emitter Leakage	I_{CEO}	—	—	100	nA	$V_{CE} = 10\text{ V}$
Reception Angle at ½ Sensitivity	θ	—	± 35	—	Degrees	
On-State Collector Current QSD422	$I_{C(ON)}$	0.3	—	1.8	mA	$E_e = 0.5\text{ mW/cm}^2$, $V_{CE} = 5\text{V}^{(6)}$
On-State Collector Current QSD423	$I_{C(ON)}$	1.2	—	4.8	mA	$E_e = 0.5\text{ mW/cm}^2$, $V_{CE} = 5\text{V}^{(6)}$
On-State Collector Current QSD424	$I_{C(ON)}$	1.8	—	—	mA	$E_e = 0.5\text{ mW/cm}^2$, $V_{CE} = 5\text{V}^{(6)}$
Rise Time	t_r	—	8.0	—	μS	$I_C = .2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$
Fall Time	t_f	—	8.0	—	μS	$I_C = .2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$
Saturation Voltage	$V_{CE(SAT)}$	—	—	0.40	V	$I_C = 0.15\text{ mA}$, $E_e = 0.5\text{ mW/cm}^2^{(6)}$

NOTES
1. Derate power dissipation linearly $1.33\text{ mW}/^\circ\text{C}$ above 25°C .
2. RMA flux is recommended.
3. Methanol or Isopropyl alcohols are recommended as cleaning agents.
4. Soldering iron tip $1/16"$ (1.6 mm) minimum from housing.
5. As long as leads are not under any stress or spring tension.
6. Light source is an AlGaAs LED emitting light at a peak wavelength of 880 nm.



PLASTIC SILICON PHOTOTRANSISTOR

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